



Docket No.: 514372000110  
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:  
Yoshihisa YAMASHITA et al.

Application No.: 10/647,263

Confirmation No.: 2075

Filed: August 26, 2003

Art Unit: 2826

For: THERMALLY CONDUCTIVE SUBSTRATE,  
THERMALLY CONDUCTIVE SUBSTRATE  
MANUFACTURING METHOD AND POWER  
MODULE

Examiner: F. ERDEM

**STATEMENT OF COMMON OWNERSHIP**

MS Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

The below signed hereby certifies that U.S. Patent Publication No. 2003/0124326 (U.S. Application No. 10/313,534) and the invention for which claims are currently pending in the above referenced application were owned by, or subject to an obligation of assignment to, Matsushita Electric Industrial Co., Ltd. at the time the above-referenced invention was made.

Dated: June 15, 2005

Respectfully submitted,

Matsushita Electric Industrial Co., Ltd

By Hiroki Naito

Name: Hiroki Naito

Title: Director, IP Development Center  
Authorized Signing Officer